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FIRST NAMED INVENTOR ATTORNEY DOCKET NO. CONFIRMATION NO. FILING DATE APPLICATION NO. Takuo Funaya Q62153 9306 12:07:2000 09/730,849

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12 10 2001

EXAMINER NHU, DAVID

PAPER NUMBER ART UNIT

2818

DATE MAILED: 12/10/2001

Please find below and/or attached an Office communication concerning this application or proceeding.

	<u> </u>			M	\mathcal{W}	
			ation No.	Applicant(s)	Tunaya IT al SCHAERER MARKUS	
Office Action Summary		09/79		SCHAERER MA		
		Exami	ner	Art Unit		
	The MAILING DATE of this commun	David	· · · · · · ·	2818		
Period fo	The MAILING DATE of this commun or Reply	ication appears on	tne cover snee	et with the correspondence a	ddress	
THE I - Exter after - If the - If NO - Failu - Any r	ORTENED STATUTORY PERIOD FOMALLING DATE OF THIS COMMUNI Insions of time may be available under the provisions SIX (6) MONTHS from the mailing date of this commorperiod for reply specified above is less than thirty (30 period for reply is specified above, the maximum state to reply within the set or extended period for reply peply received by the Office later than three months and patent term adjustment. See 37 CFR 1.704(b).	CATION. of 37 CFR 1.136(a). In no unication. D) days, a reply within the tutory period will apply an will. by statute cause the	event, however, management of the statutory minimum of will expire SIX (6) application to become	ay a reply be timely filed of thirty (30) days will be considered tim MONTHS from the mailing date of this	ely. communication.	
1) 🖂	Responsive to communication(s) file	ed on <u>20 Novemb</u>	er 2001 .			
2a) <u></u> □	This action is FINAL .	2b)⊠ This action	is non-final.			
3)	Since this application is in condition closed in accordance with the pract	for allowance exc ice under <i>Ex parte</i>	ept for formal <i>Quayle</i> , 1935	matters, prosecution as to t C.D. 11, 453 O.G. 213.	he merits is	
Dispositi	on of Claims					
4) 🖾	Claim(s) 111 is/are pending in the	application.				
•	4a) Of the above claim(s) <u>9-11</u> is/are	withdrawn from co	nsideration.			
5)	Claim(s) is/are allowed.					
6)⊠	Claim(s) <u>1-8</u> is/are rejected.					
7)	Claim(s) is/are objected to.					
8) 🗌	Claim(s) are subject to restrict	tion and/or election	requirement.			
Application	on Papers					
9) 🗌 ७	he specification is objected to by the	Examiner.				
10)[] T	he drawing(s) filed on is/are:	a) accepted or b)	objected to !	by the Examiner.		
	Applicant may not request that any object	ection to the drawing	(s) be held in at	peyance. See 37 CFR 1.85(a).		
11) 🗌 T	he proposed drawing correction filed	on is: a)	approved b)	disapproved by the Examir	ner.	
	If approved, corrected drawings are req	, •	Office action.			
12) 🗌 T	he oath or declaration is objected to	by the Examiner.				
Priority u	nder 35 U.S.C. §§ 119 and 120					
13) 🖂 .	Acknowledgment is made of a claim t	for foreign priority	under 35 U.S.	C. § 119(a)-(d) or (f).		
a)[∑	☑ All b) ☐ Some * c) ☐ None of:					
	 Certified copies of the priority of 	locuments have be	een received.			
:	Certified copies of the priority of	locuments have be	en received i	n Application No		
	3. Copies of the certified copies o application from the Internate the attached detailed Office action	itional Bureau (PC	T Rule 17.2(a)).	Stage	
14) 🗌 Ad	cknowledgment is made of a claim fo	r domestic priority	under 35 U.S.	C. § 119(e) (to a provisiona	l application)	
_	☐ The translation of the foreign lang				,	
Attachment(
2) 🔲 Notice	of References Cited (PTO-892) of Draftsperson's Patent Drawing Review (PT ation Disclosure Statement(s) (PTO-1449) Pap	O-948) per No(s) <u>2</u>		ew Summary (PTO-413) Paper No of Informal Patent Application (PT		
Patent and Trail O-326 (Rev.		Office Action Sumn	nary	Part o	of Paper No. 7	

م کو ہے گار ہے۔ Application/Control Number: 09/703,849

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DETAILED ACTIONS

Election/Restrictions

Applicant's election of Group I (Claims 1-8) in page No.6 is acknowledge.

Claims 1-8 are remained for examination. Accordingly, claims 9-11 are withdrawn from consideration as being directed to a non-elected invention. See 37 CFR 1.142(b) and MPEP § 821.03.

Specifications

Content of Specification

1. The disclosure is objected to because of the following informalities: Field of the Invention and Description of the Related Art are missing. Appropriate correction is required.

Background of the Invention: The specification should set forth the Background of the Invention in two parts:

- (a) <u>Field of the Invention</u>: A statement of the field of art to which the invention pertains. This statement may include a paraphrasing of the applicable U.S. patent classification definitions of the subject matter of the claimed invention. This item may also be titled "Technical Field."
- (b) <u>Description of the Related Art</u>: A description of the related art known to the applicant and including, if applicable, references to specific related art and problems involved in the prior art which are solved by the applicant's invention. This item may also be titled "Background Art."

Claim Rejections - 35 USC § 112

2. The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

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3. Claims 3, 5, 7, 8 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

Claims 3, 5, 7, 8 are not clear as said resin layer would effect a device characteristic.

Claim Rejections - 35 USC § 102

4. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

5. Claims1-8 are rejected under 35 U.S.C. 102(b) as being anticipated by Kondo et al (5,283,468).

Regarding claim 1, see Kondo, figures 1-45, and related text on col. 1-42, which disclose an assembly in which a plurality of electronic devices 101, 104 of different kinds are connected to a single electronic device, said electronic devices are connected to each other by conductive portions 107, 108, 109, 121, 150 implemented by metal, but insulated from each other by insulating portions 111 implemented by an adhesive, sealable patterned resin layer 123. See Kondo, figures 5a-5b, 6a-6c, 18a-18b, 19a-19b, 20a-20b, col. 16, lines 30-67, col. 17, lines 1-67, col. 18, lines 1-25, col. 21, lines 30-67, col. 22, lines 1-10, col. 6, lines 5-67, col. 11-12, lines 1-67, col. 13, lines 11-60.

Regarding claim 2, an assembly as claimed in claim 1, wherein said resin layer is thermosetting and photoconductive. See Kondo, col. col. 7, lines 50-67, col. 8, lines 1-30, col. 10, lines 21-46, col. 13, lines 11-45.

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Regarding claim 3, an assembly as claimed in claim 2, wherein said resin layer 123 is so patterned as to be absent around wiring portions 121 protruding from said electronic devices 101, around portions of circuit surface 104 of said electronic devices where resin forming said resin layer is effect a device characteristic, around electrode pads 102, 105, and around bumps 107, 108, 109 formed on said electrode pads. See figures 5a-5b, 6a-6c, 19a-19b, 20a-20b, col. 16, lines 30-67, col. 17, lines 1-67, col. 18, lines 1-25, col. 21, lines 30-67, col. 22, lines 1-10, col. 6, lines 5-67.

Regarding claim 4, an assembly as claimed in claim 2, wherein said resin layer has a function for flip chip bonding and a function for passivation. See col. 12, lines 47-67, col. 13, lines 1-45. **Regarding claim 5,** an assembly as claimed in claim 4, wherein said resin layer 123 is so patterned as to be absent around wiring portions 121 protruding from said electronic devices 101, around portions of circuit surface 104 of said electronic devices where resin forming said resin layer is effect a device characteristic, around electrode pads 102, 105, and around bumps 107, 108, 109 formed on said electrode pads. See figures 5a-5b, 6a-6c, 19a-19b, 20a-20b, col. 16, lines 30-67, col. 17, lines 1-67, col. 18, lines 1-25, col. 21, lines 30-67, col. 22, lines 1-10, col. 6, lines 5-67.

Regarding claim 6, an assembly as claimed in claim 1, wherein said resin layer has a function for flip chip bonding and a function for passivation. See col. 12, lines 47-67, col. 13, lines 1-45.

Regarding claim 7, an assembly as claimed in claim 6, wherein said resin layer 123 is so patterned as to be absent around wiring portions 121 protruding from said electronic devices 101, around portions of circuit surface 104 of said electronic devices where resin forming said resin layer is effect a device characteristic, around electrode pads 102, 105, and around

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bumps 107, 108, 109 formed on said electrode pads. See figures 5a-5b, 6a-6c, 19a-19b, 20a-20b, col. 16, lines 30-67, col. 17, lines 1-67, col. 18, lines 1-25, col. 21, lines 30-67, col. 22, lines 1-10, col. 6, lines 5-67.

Regarding claim 8, an assembly as claimed in claim 1, wherein said resin layer 123 is so patterned as to be absent around wiring portions 121 protruding from said electronic devices 101, around portions of circuit surface 104 of said electronic devices where resin forming said resin layer is effect a device characteristic, around electrode pads 102, 105, and around bumps 107, 108, 109 formed on said electrode pads. See figures 5a-5b, 6a-6c, 19a-19b, 20a-20b, col. 16, lines 30-67, col. 17, lines 1-67, col. 18, lines 1-25, col. 21, lines 30-67, col. 22, lines 1-10, col. 6, lines 5-67.

Conclusion

- 6. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure: Pasch'624, Black'008 are cited as of interest.
- 7. A shortened statutory period for response to this action is set to expired 3 (three) months and 0 (zero) day from the date of this letter. Failure to respond within the period for response will cause the application to become abandoned (see 710.02 (b)).
- 8. Any inquiry concerning this communication on earlier communications from the examiner should be directed to David Nhu, (703) 306-5796. The examiner can normally be reached on Monday-Friday from 7:30 AM to 5:00 PM. The examiner's supervisor, David Nelms can be reached on (703) 308-4910.

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The fax phone number for the organization where this application or proceeding is assigned is (703) 308-7724.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956

David Nhu

Du

November 28, 2001

David Nelms Supervisory Patent Examiner Technology Center 2800